Degree of Conversion of Adhesive Systems Light-Cured By LED and Halogen Light

Cesar Augusto Galvão ARRAIS1
Fenelon Martinho PONTES2
Luis Presley Serejo dos SANTOS2
Edson Roberto LEITE2
Marcelo GIANNINI1

1Department of Restorative Dentistry, School of Dentistry of Piracicaba, State University of Campinas, Piracicaba, SP, Brazil
2Interdisciplinary Laboratory of Electrochemistry and Ceramics, Department of Chemistry, Federal University of São Carlos, São Carlos, SP, Brazil

This study evaluated the effect of blue light emitting diode (LED) and quartz tungsten halogen (QTH) on the degree of conversion (DC) of an etch-and-rinse Single Bond adhesive system (SB) and a mixture composed of primer solution and resin bond from Clearfil SE Bond self-etching adhesive system (CB) using Fourier transform infrared analysis (FTIR). Adhesives were applied to potassium bromide pellet surfaces and FTIR analyses were performed before and after photo-activation for 10 s with either LED (Freelight 1 – 400 mw/cm²) or QTH (XL 3000 – 630 mw/cm²) light-curing units (n=8). Additional FTIR spectra were obtained from photo-activated samples stored in distilled water for 1 week. The DC was calculated by comparing the spectra obtained from adhesive resins before and after photo-activation. The results were analyzed by two-way split-plot ANOVA and Tukey’s test (p<0.05). Both adhesive systems exhibited low DC (%) immediately after photo-activation (SB/QTH: 18.7 ± 3.9; SB/LED: 13.5 ± 3.3; CF/QTH: 13.6 ± 1.9; CF/LED: 6.1 ± 1.0). The DC of samples light-cured with LED was lower than DC of those light-cured with QTH, immediately after light curing and after 1 week (SB/QTH: 51.3 ± 6.6; SB/LED: 50.3 ± 4.8; CF/QTH: 56.5 ± 2.9; CF/LED: 49.2 ± 4.9). The LED curing unit used to photo-activate the adhesive resins promoted lower DC than the QTH curing unit both immediately after light curing and 1 week after storage in water.

Key Words: LED, halogen lamp, degree of conversion, adhesive system.

INTRODUCTION

For many years quartz-tungsten-halogen bulbs have been used as the lighting source to photo-activate visible-light cured composite resins. However, some factors may compromise the performance of halogen light curing units (LCUs), such as fluctuations in the line voltage, the condition of the bulb and filter, contamination of the light guide, damage to the fiber-optic bundle as well as bulb overheating within the unit. These factors can contribute to reduce the efficiency and lifetime of halogen lamps, leading to poorly polymerized composite resins with impaired mechanical properties (1).

Blue light emitting diode (LED) technology has been indicated as an alternative to conventional halogen lights. LED LCUs consume little power in operating and do not require filters to produce blue light. Moreover, the semiconductors used for light emission instead of hot metal filaments found in halogen bulbs generate less heat and undergo little degradation over time. The gallium nitride LEDs produce a narrow wavelength peak around 470 nm, which matches the absorption peak value of camphorquinone, the most common photoabsorbing compound that initiates the polymerization of resin monomers in dental restorative composites (2).

Some mechanical and physical properties of resin composites light-cured by LED have been reported,
such as compressive and flexural strength, hardness, degree of conversion and depth of cure. Although LED polymerization technology tends to reach the performance level of halogen LCUs (3-6), additional studies are needed to determine the degree of conversion of dental resin-based materials (7,8).

Optimal monomer infiltration into the demineralized collagen network and achievement of high degrees of monomer conversion are crucial factors for establishing long-lasting resin/dentin bonding (9). Some factors might affect the conversion of resin monomer, such as the residual water or organic solvents, and the quality of the light source applied to photo-activate the adhesive systems. Although there are several reports about the effects of LED on composite resins, little-to-no studies exist about the efficiency of LED on the degree of conversion of adhesive systems (10). This study evaluated the degree of monomer conversion of two adhesive systems photo-activated with LED and halogen LCUs, using Fourier transform infrared (FTIR) analysis. The null hypothesis was that there is no difference in the degree of conversion when adhesive systems are photo-activated by LED or halogen LCUs.

**MATERIAL AND METHODS**

The adhesive systems investigated were: Single Bond (3M/ESPE, St. Paul, MN, USA) and Clearfil SE Bond (Kuraray Medical Inc., Kurashiki, Okayama, Japan). Two commercially available LCUs (Table 1) were tested: XL 3000 halogen-based (3M ESPE – light intensity: 550-630 mw/cm²) and Elipar Freelight 1 LED-based (3M ESPE - light intensity: 400 mw/cm²). Thus, 4 experimental groups (n=5) were formed and evaluated, according to the factors under study (adhesive system and LCU).

For FTIR analysis of Single Bond, one drop of the adhesive resin solution was placed into mixing well. An applicator tip was dipped into adhesive solution and the adhesive was applied to the surface of a potassium bromide pellet. Single Bond adhesive was air dried for 10 s, following the manufacturer’s instructions, before curing for 10 s. Clearfil SE Bond specimens were prepared by mixing four drops of bonding resin and one drop of primer in a mixing well and air dried for 90 s. One adhesive layer was applied using an applicator tip and light-cured for 10 s. The adhesive systems were light cured without Mylar strip over adhesive layer.

FTIR spectra of non-polymerized adhesive solution were obtained using 20 scans at 4 cm⁻¹ in the transmittance mode (Equinox 55; Bruker Optik GmbH, Ettlingen, Germany). Additional FTIR spectra were obtained immediately after 10-s light-curing and after sample storage in distilled water for 1 week.

For calculating the DC, the aliphatic carbon-to-carbon double bond absorbance peak intensity located at 1638 cm⁻¹ and that for the aromatic component located at 1608 cm⁻¹ (aromatic) were compared in each spectrum before and after the polymerization reaction, and monomer conversion was determined using the following equation (11): (% C = C) = [abs (aliphatic C = C)/abs (aromatic C . . .C)] polymer + [abs (aliphatic C = C)/abs (aromatic C . . . C)] monomer x 100, where (% C = C) = Percentage of remaining carbon double bonds and abs = absorbance.

DC was obtained by subtracting the percentage of remaining carbon double bonds (% C = C) from 100%. Conversion data were analyzed by two-way split-plot ANOVA and Tukey’s post-hoc test (α = 0.05).

**RESULTS**

Table 2 to 4 show the DC means and standard deviations for adhesive systems light cured with halogen and LED-based LCUs. Two-way ANOVA revealed that there were statistically significant differences for the factor “adhesive system” (p = 0.00001), for the factor “curing unit” (p = 0.00001) and for factor interactions (p = 0.01432).

Tukey’s test showed that the DC of Single Bond

<table>
<thead>
<tr>
<th>Curing unit</th>
<th>Power source</th>
<th>Light type</th>
<th>Tip diameter (mm)</th>
<th>Light source</th>
</tr>
</thead>
<tbody>
<tr>
<td>XL-3000</td>
<td>Mains</td>
<td>Quartz tungsten halogen (QTH)</td>
<td>8</td>
<td>1 QTH bulb</td>
</tr>
<tr>
<td>Elipar Freelight 1</td>
<td>Battery</td>
<td>Light emitting diode (LED)</td>
<td>6</td>
<td>19 LED in an array</td>
</tr>
</tbody>
</table>

Table 1. Specifications and technical details of the light-curing units used in this study.
was higher than that of Clearfil SE Bond photo-activated with LED-based LCUs. The monomer conversion of both Single Bond and Clearfil SE Bond adhesive systems was affected by LCU type (Table 2). The adhesive systems exhibited low DC immediately after phot activation with both LCUs (Tables 3 and 4). The DC of specimens light-cured with LED was lower than those light-cured with halogen light, either immediately after light curing or after 1 week of storage (Tables 2 to 4).

Figure 1 shows the spectrum sites obtained from Single Bond and Clearfil SE Bond before and immediately after light curing, as well as after 1 week of storage in water. These sites were used to calculate the DC. Figures 1A and 1B exhibit the spectrum sites obtained from Single Bond light cured by halogen light and LED LCUs, respectively, while Figures 1C and 1D corresponds to the sites from Clearfil SE Bond light cured by halogen light and LED LCUs. There was little reduction in the peak located at 1638 cm⁻¹ after 10 s of light curing for both adhesive systems. Compared to the spectra obtained from samples immediately after curing by halogen light, the spectra obtained from samples light cured with LED demonstrate an apparently smaller reduction in the peak corresponding to carbon-double bonds (1638 cm⁻¹ – Figs. 1B and 1D). After 1 week of storage in water, a pronounced reduction in the same peak was observed for both Single Bond and Clearfil SE Bond.

**DISCUSSION**

The degree of monomer conversion depends on the output and wavelength of the light, exposure time and composition of light-activated resin-based material. In this study, the tested resin-based materials were adhesive systems, that were light cured with two commercially available LCUs. The results indicated that the LED-based LCU did not polymerize the adhesive systems at different times of post-light curing like conventional halogen lamps do, therefore, the null hypothesis was rejected.

One possible reason for this result may be the difference in light intensities. The light intensity of the halogen LCU evaluated in this study is about 600 mW/cm², while the LED LCU has light intensity of approximately 400 mW/cm². The higher light intensity promotes higher wavelength peak at 470 nm and more camphorquinone molecules will be excited. As a consequence, more free radicals are generated and faster monomer conversion will occur, resulting in higher DC in shorter time (12). Some studies have suggested that halogen light still produce greater curing energy and higher degree of composite monomer conversion than the first generation of LED lights (7,8,13).

Halogen LCUs generate heat during operation, increasing the temperature on the surface. Based on the
fact that the adhesive systems are spread into a layer thinner than that of restorative composites prior light curing (10), the rise of surface temperature that occurs during polymerization can additionally improve the rate of polymerization. The heat can be absorbed, increasing the molecular movements and the collisions, which can contribute to increase the DC (1,6,14,15).

A great amount of unpolymerized monomers from Clearfil SE Bond adhesive were detected by FTIR analysis immediately after LED photo-activation. Regardless of the lower power density emitted by LED (7,8,13), differences in resin adhesive composition and sample preparation might have affected the DC when LED LCU was tested. The mixture of Bond and Primer of Clearfil SE Bond results in a solution with low pH (approximately 2) and high water content, which can impair the polymerization reaction of the adhesive. The Clearfil SE Bond samples were composed of the mixture of four drops of Bond and one drop of Primer in an attempt to reduce the water content and increase the monomer pH that allows the polymer conversion to occur. When applied to tooth surface, the self-etching primer acidity can be buffered by mineral content of dentin and enamel (18), allowing the higher monomer conversion. The changes for preparations of Clearfil SE Bond samples, such as reduction of the water content from Primer solution and the increase in Bis-GMA content, might have altered the adhesive material, which would modify the maximal rate of conversion and the result of the polymerization reaction (19).

Like when adhesive systems are applied clinically, the contact between resin adhesive and atmospheric oxygen was not avoided during the photo-activation of adhesive samples (16,17). This might

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Figure 1. FTIR spectrum sites obtained from Single Bond and Clearfil SE Bond adhesive resins before light exposure (dotted line), immediately after light exposure (α) and after 1 week (β). Little reduction in the peak located at 1638 cm⁻¹ was observed immediately after light exposure (α) when Single Bond was light-cured with halogen light (A) or LED (B). FTIR analysis of Clearfil SE Bond exhibited similar reduction when halogen light was applied (C), while this reduction was less pronounced when LED was used (D). After 1 week, FTIR analysis of all samples exhibited a pronounced reduction in the same peak (β).
RESUMO

Este estudo avaliou a influência de sistemas de fotoativação no grau de conversão (GC) de sistemas adesivos por meio da análise infravermelha transformada de Fourier (FTIR). Os sistemas adesivos Single Bond (SB) e Clearfil SE Bond (CF) foram aplicados em pastilhas de brometo de potássio e fotoativados com luz halógena (XL 3000 – 400 mw/cm²) (QTH) e LED (Elipar Freelight 1 – 400 mw/cm²) por 10 s (n=8). Foram obtidos espectros de FTIR antes e imediatamente após a fotoativação, e também após 1 semana de armazenamento em água destilada. Calculou-se o GC comparando-se a razão entre os picos das bandas dos espectros, antes e após a fotoativação. Os resultados de GC foram submetidos à ANOVA e ao teste de Tukey (p<0,05). Para ambos os sistemas adesivos, o GC (%) obtido imediatamente após a fotoativação com LED foi inferior ao obtido utilizando-se QTH (SB/QTH: 18,7 ± 3,9; SB/LED: 13,6 ± 3,3; CF/QTH: 13,6 ± 1,9; CF/LED: 6,1 ± 1,0). Após uma semana foi observado um aumento significativo no GC de todos os grupos, porém os valores dos grupos fotoativados com LED manteve-se inferiores aos obtidos com QTH (SB/QTH: 51,3 ± 6,6; SB/LED: 50,3 ± 4,8; CF/QTH: 56,5 ± 2,9; CF/LED: 49,2 ± 4,9). O GC dos adesivos fotoativados com LED foi inferior ao observado após fotoativação com QTH, imediatamente após fotoativação como após 1 semana de armazenamento em água.

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